

US00D877103S

(12) **United States Design Patent** (10) **Patent No.:** **US D877,103 S**  
**Venk et al.** (45) **Date of Patent:** **\*\* Mar. 3, 2020**

(54) **CONDUCTOR PAD**

(71) Applicants: **Sridharan Venk**, Treviso (IT); **Earl Alfred Picard, Jr.**, Portsmouth, NH (US); **Qi Dai**, Shanghai (CN); **Richard Garner**, Arlington, MA (US)

(72) Inventors: **Sridharan Venk**, Treviso (IT); **Earl Alfred Picard, Jr.**, Portsmouth, NH (US); **Qi Dai**, Shanghai (CN); **Richard Garner**, Arlington, MA (US)

(73) Assignee: **OSRAM SYLVANIA Inc.**, Wilmington, MA (US)

(\*\*) Term: **15 Years**

(21) Appl. No.: **29/680,129**

(22) Filed: **Feb. 13, 2019**

**Related U.S. Application Data**

(62) Division of application No. 29/584,216, filed on Nov. 12, 2016, now Pat. No. Des. 844,577, which is a  
(Continued)

(51) **LOC (12) Cl.** ..... **13-03**

(52) **U.S. Cl.**  
USPC ..... **D13/182**

(58) **Field of Classification Search**  
USPC ..... D13/133, 182; 324/754.01, 754.02,  
324/754.03; 361/19, 107, 637, 515, 813;  
(Continued)

(56) **References Cited**

**U.S. PATENT DOCUMENTS**

D327,883 S \* 7/1992 Gloton ..... D13/182  
D328,599 S \* 8/1992 Gloton ..... D13/182  
(Continued)

*Primary Examiner* — Elizabeth J Oswecki

(74) *Attorney, Agent, or Firm* — Shaun P. Montana

(57) **CLAIM**

The ornamental design for a conductor pad, as shown and described.

**DESCRIPTION**

FIG. 1 is a top plan view of a first embodiment of a conductor pad showing our new design, the bottom plan view being a mirror image thereof.

FIG. 2 is a top plan view of a second embodiment of a conductor pad showing our new design, the bottom plan view being a mirror image thereof.

FIG. 3 is a top plan view of a third embodiment of a conductor pad showing our new design, the bottom plan view being a mirror image thereof.

FIG. 4 is a top plan view of a fourth embodiment of a conductor pad showing our new design, the bottom plan view being a mirror image thereof.

FIG. 5 is a top plan view of a fifth embodiment of a conductor pad showing our new design, the bottom plan view being a mirror image thereof.

FIG. 6 is a top plan view of a sixth embodiment of a conductor pad showing our new design, the bottom plan view being a mirror image thereof.

FIG. 7 is a top plan view of a seventh embodiment of a conductor pad showing our new design, the bottom plan view being a mirror image thereof.

FIG. 8 is a top plan view of an eighth embodiment of a conductor pad showing our new design, the bottom plan view being a mirror image thereof.

FIG. 9 is a top plan view of a ninth embodiment of a conductor pad showing our new design, the bottom plan view being a mirror image thereof.

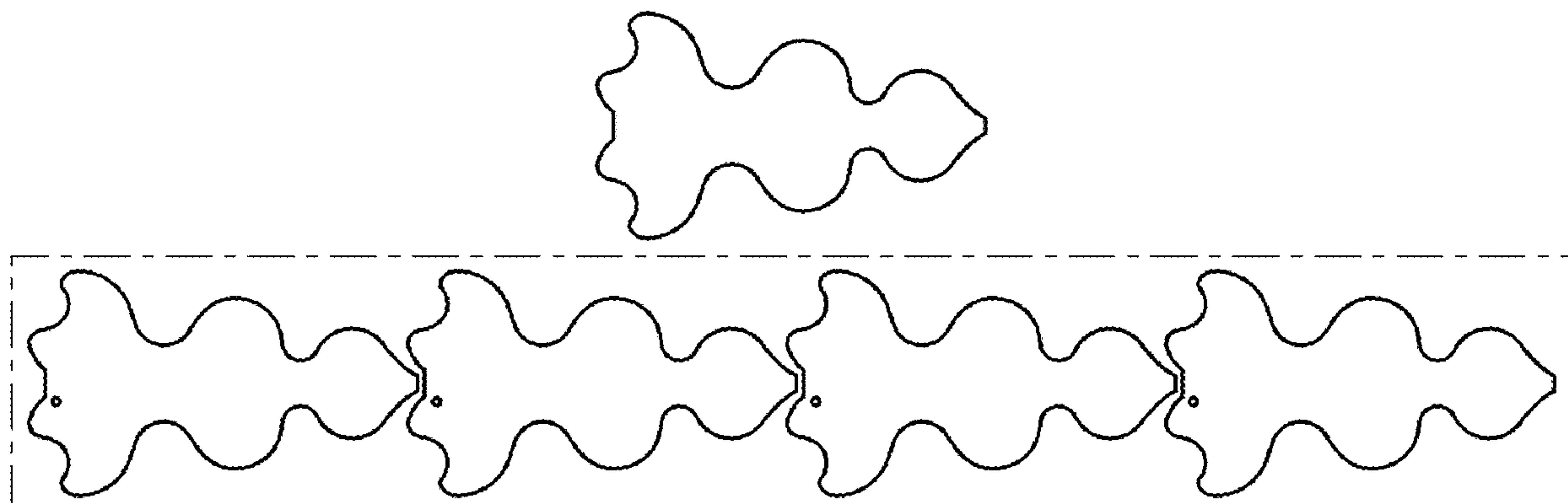
FIG. 10 is a top plan view of a tenth embodiment of a conductor pad showing our new design, the bottom plan view being a mirror image thereof.

FIG. 11 is a top plan view of an eleventh embodiment of a conductor pad showing our new design, the bottom plan view being a mirror image thereof; and,

FIG. 12 is a top plan view of a twelfth embodiment of a conductor pad showing our new design, the bottom plan view being a mirror image thereof.

The broken-line disclosure in the views is understood to represent portions of the article in which the claimed design is embodied, but which form no part of the claimed design. All surfaces not shown form no part of the claimed design.

**1 Claim, 3 Drawing Sheets**



Related U.S. Application Data

division of application No. 29/486,410, filed on Mar. 28, 2014, now Pat. No. Des. 774,477.

(58) Field of Classification Search

USPC ..... 439/43, 52, 66, 12, 208, 210, 456, 457, 439/458, 902; 438/614, 610, 584, 612, 438/618

CPC ... H01L 24/03; H01L 24/05; H01L 23/49575; H01L 24/34; H01L 2224/05556; H01J 37/08; H01J 37/26; G01N 23/00

See application file for complete search history.

(56) References Cited

U.S. PATENT DOCUMENTS

6,803,582 B2 \* 10/2004 Berglund ..... B82Y 10/00 250/310  
D503,691 S \* 4/2005 Standing ..... H01L 24/63 D13/182  
D598,380 S \* 8/2009 Kuriki ..... D13/133  
D613,690 S \* 4/2010 Kuriki ..... D13/133  
D615,927 S \* 5/2010 Kuriki ..... D13/133  
8,791,560 B2 \* 7/2014 Hu ..... H01L 23/49541 257/666  
9,082,626 B2 \* 7/2015 Gatterbauer ..... H01L 23/147  
D774,477 S \* 12/2016 Venk ..... D13/182

\* cited by examiner

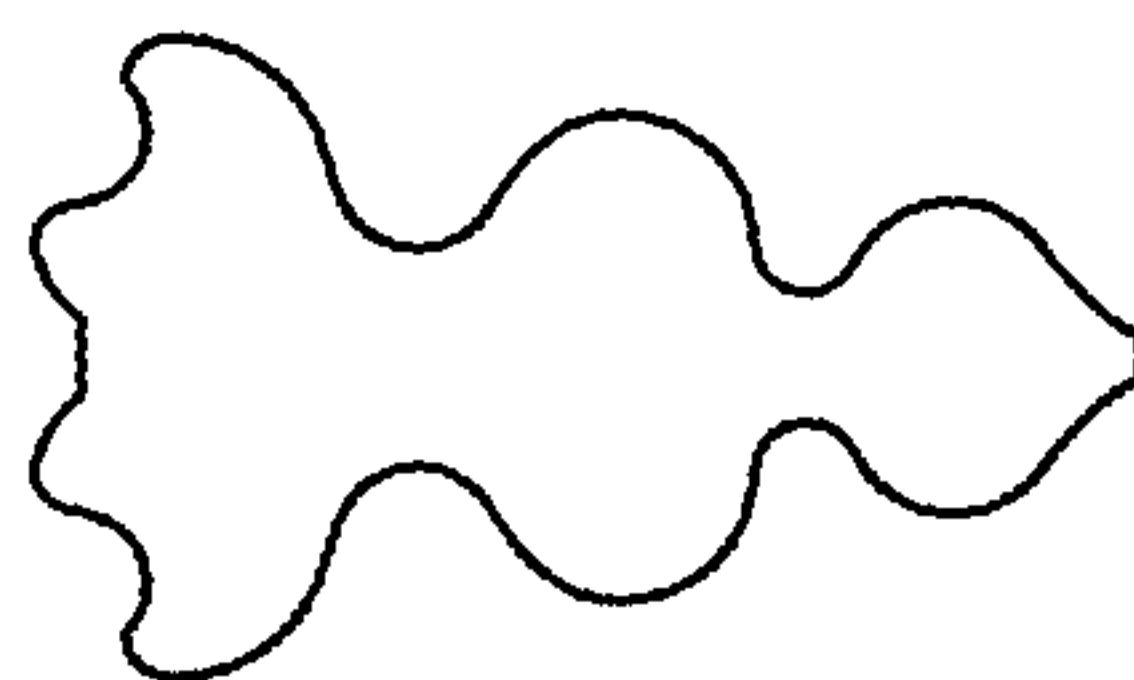


FIG. 1

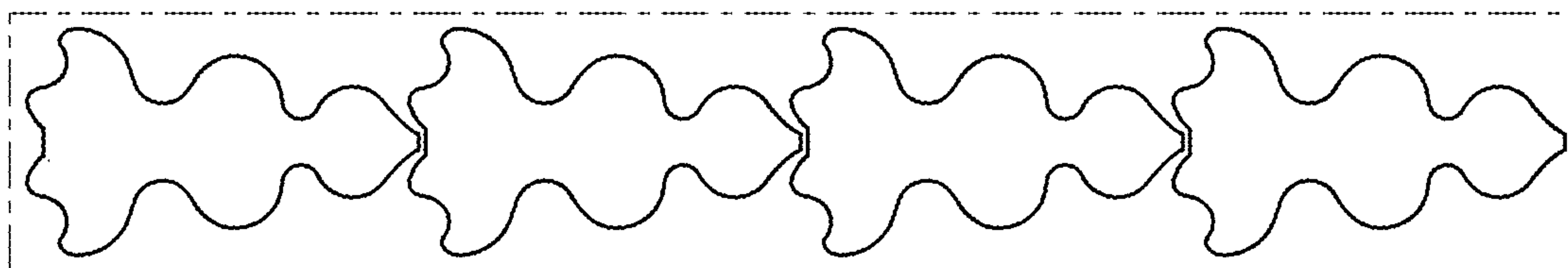


FIG. 2

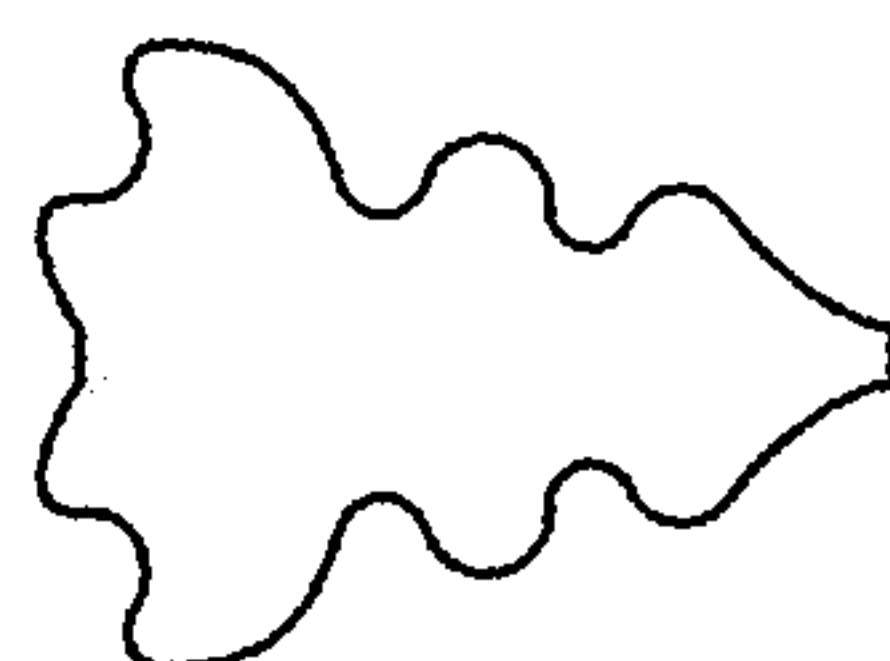


FIG. 3

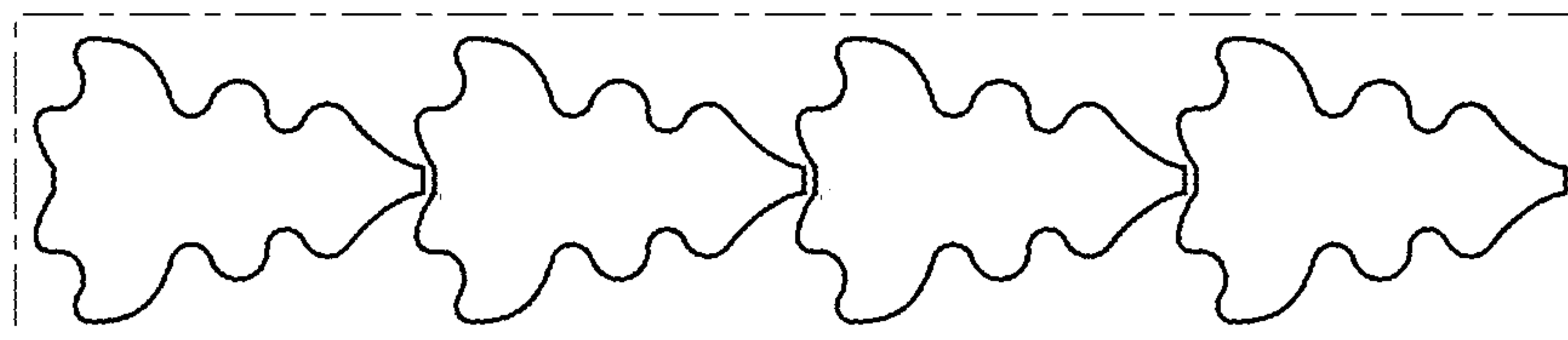


FIG. 4

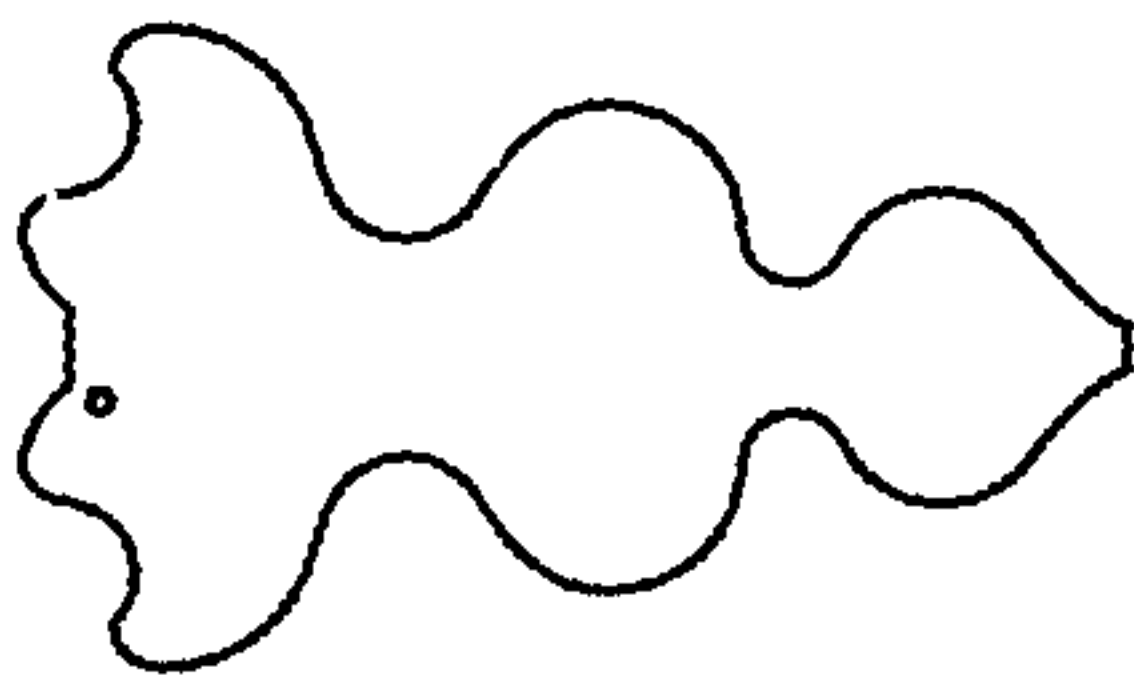


FIG. 5

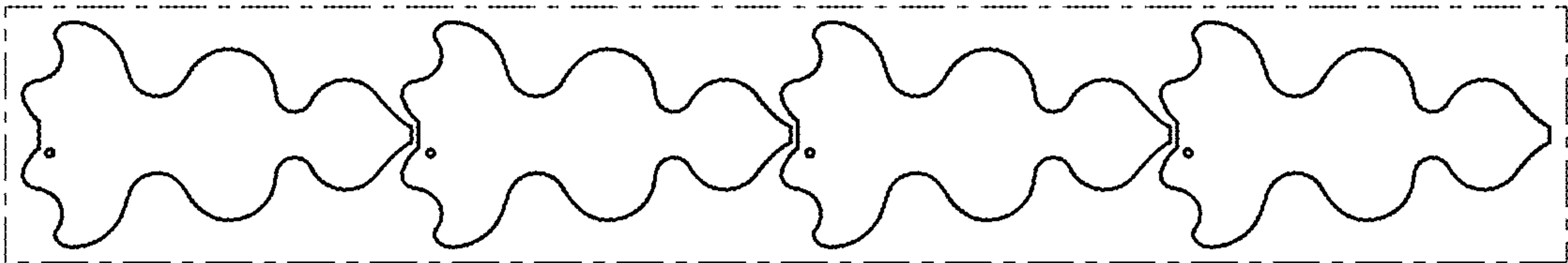


FIG. 6

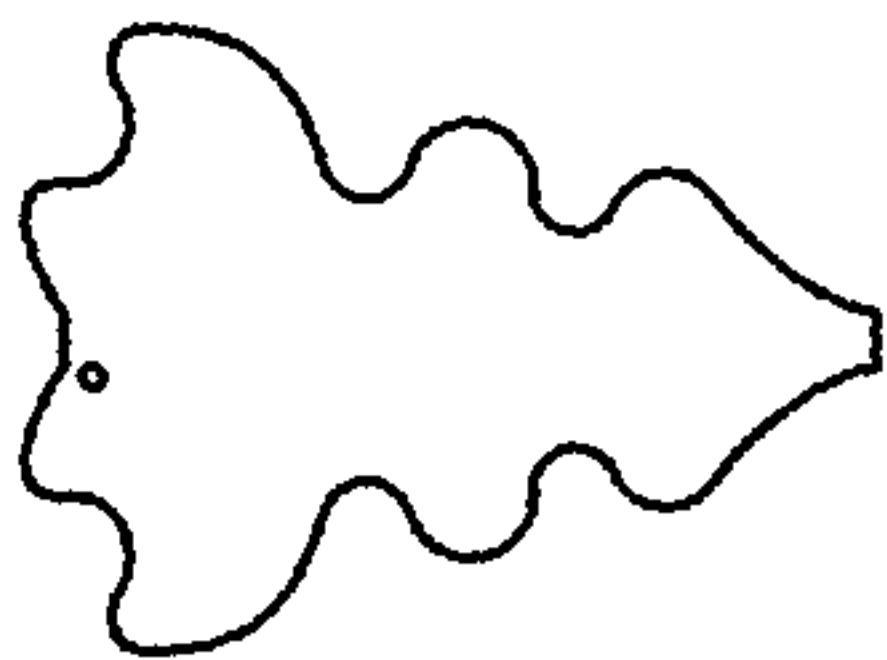


FIG. 7

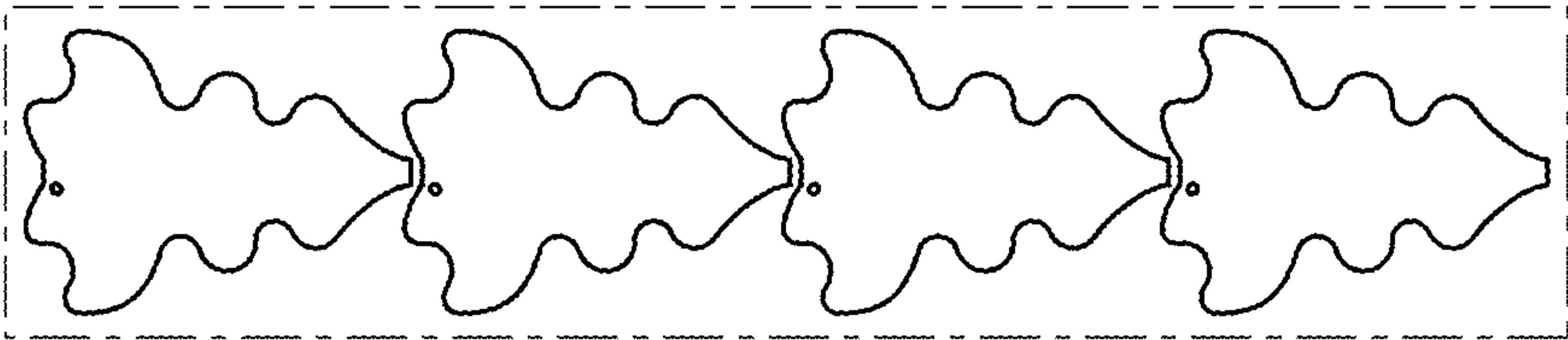


FIG. 8

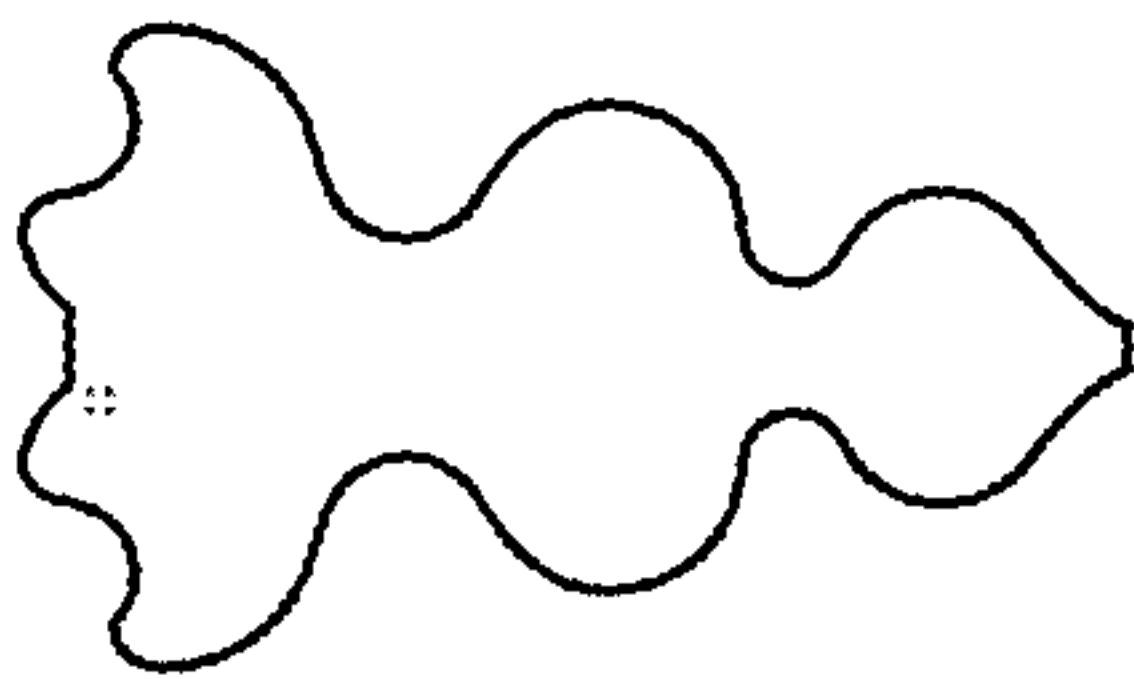


FIG. 9

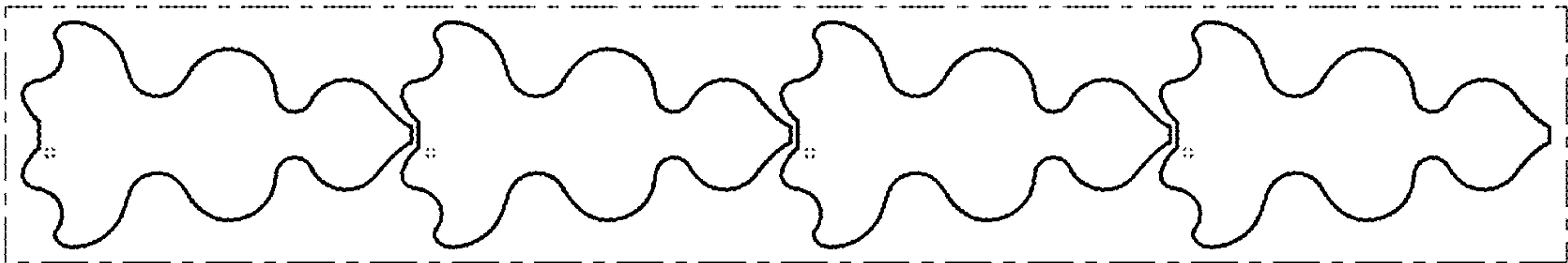


FIG. 10

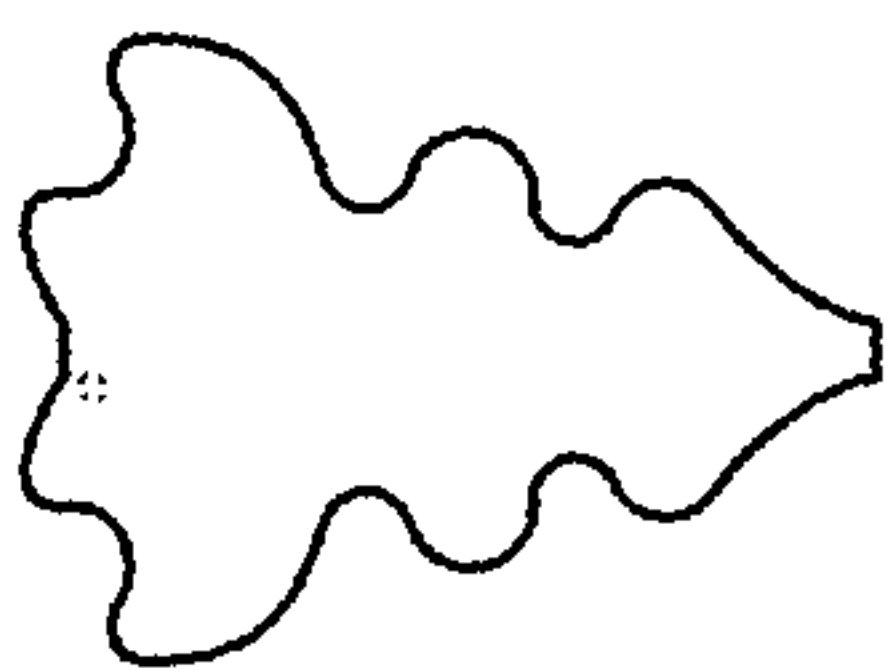


FIG. 11

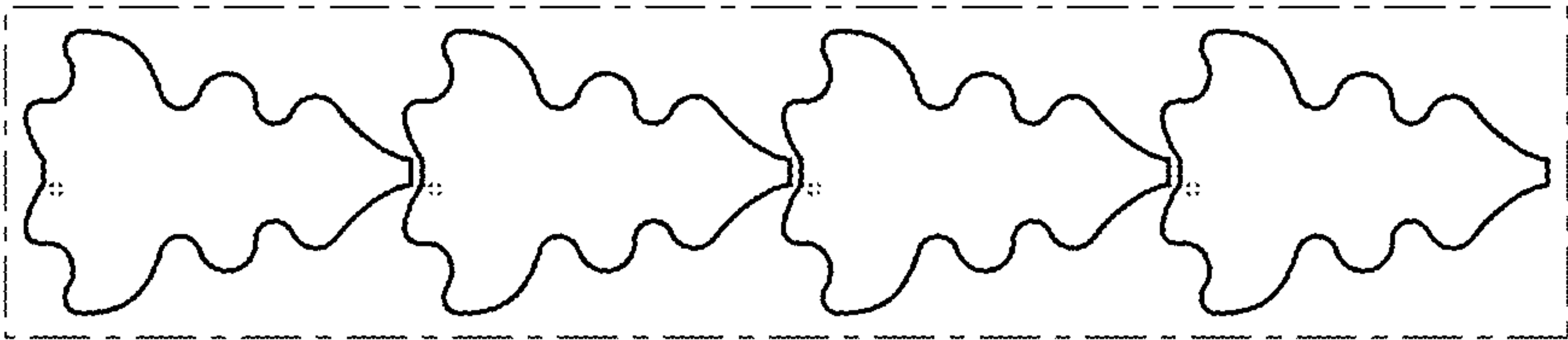


FIG. 12